



Medical Intelligence with Interoperability and Standard (APAMI 2022)

Guest Editors:

Prof. Dr. Chien-Yeh Hsu

Dr. Hsiu-An Lee

Prof. Dr. Chi-Ming Chu

Prof. Dr. Kuo-Chung Chu

Deadline for manuscript
submissions:

closed (30 April 2023)

Message from the Guest Editors

Dear colleagues,

The Asia-Pacific Association for Medical Informatics (APAMI 2022) covers a wide range of fields in medical and healthcare technology and aims to bring together medical and technological expertise. During the conference, there should be substantial time for presentations and discussions. In addition, exhibitions offer ample opportunities for the exchanging of information among delegates and participants, especially for those who are looking for new opportunities between presenters and participants.

The research theme is “Medical Intelligence with Interoperability and Standard”, which the WHO has been promoting globally, and we also invite many papers in any field in medical informatics from all over the world.

This special session will provide you with an excellent opportunity to establish new relationships with professional colleagues from various nations, including those in the Asia-Pacific region.

Aside from these conference papers, general Special Issue papers can be accepted for submission to our Special Issue.





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Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica,
Politecnico di Milano, Piazza L.
da Vinci 32, 20133 Milano, Italy

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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Applied Sciences Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

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